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## APPLICANTS

Shinji Maekawa, Kanagawa, JAPAN;

\*\* CONTINUING DATA \*\*\*\*\* None *S.W.S.*\*\* FOREIGN APPLICATIONS \*\*\*\*\* *S.W.S.*  
JAPAN 11-336850 11/26/1999

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 27	<b>TOTAL CLAIMS</b> 43	<b>INDEPENDENT CLAIMS</b> 14
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged <i>S.W.S.</i> Examiner's Signature Initials				

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## TITLE

METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE THAT INCLUDES FORMING A MATERIAL WITH A HIGH TENSILE STRESS IN CONTACT WITH A SEMICONDUCTOR FILM TO GETTER IMPURITIES FROM THE SEMICONDUCTOR FILM

<b>FILING FEE RECEIVED</b> 3510	<b>FEES:</b> Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT. No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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